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Product Specifications Approval Sheet

Product Description: Crystal Unit SMD 3.2x2.5 25.00MHz

TST Part No.: TZ2790A

Customer Part No.:_____

Customer signature re	equired	
Company:		
Division:		
Approved by :		
Date:		
		1
Checked by:	Chia Haur Rau	CH
Approved by:		Kuly Huang
Date:	05/30/2019	J V

- 1. Customer signed back is required before TST can proceed with sample build and receive orders.
- 2. Orders received without customer signed back will be regarded as agreement on the specifications.
- 3. Any specifications changes must be approved upon by both parties and a new revision of specifications shall be released to reflect the changes.

TAI-SAW TECHNOLOGY CO., LTD. Crystal Unit SMD 3.2x2.5 25.00MHz

MODEL NO.: TZ2790A

REV. NO.: 1

Revise:

1 N/.	A	Initial release			
			05/30/19'	N/A	Chia Haur Rau

2/7

TAI-SAW TECHNOLOGY CO., LTD. Crystal Unit SMD 3.2x2.5 25.00MHz

MODEL NO.: TZ2790A

REV. NO.: 1

Features:

- Surface Mount Hermetic Package
- Excellent Reliability Performance
- Good Frequency Perturbation and Stability over temperature
- Ultra Miniature Package
- Moisture Sensitivity Level (MSL) : Level-1

Description and Applications:

Surface mount 3.2mmx2.5mm crystal unit for customer for use in wireless communications devices, especially for a need of ultra miniature package for mobility.

Electrical Specifications:

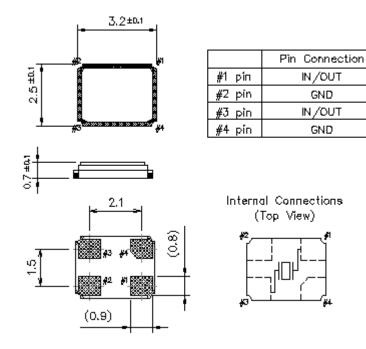
TZ2790A	Specification
Nominal Frequency	25.00000 MHz
Mode of Oscillation	Fundamental
Storage Temperature Range	-40°C to +125°C
Operating Temperature Range	-30°C to +100°C
Frequency Stability over Operating Temperature	+/- 15 ppm (-30 to 85°C referred to the value at 25°C) +/- 20 ppm (85 to 100°C referred to the value at 25°C)
Frequency Make Tolerance (FL)	+/- 10 ppm @ 25°C +/- 3°C
Equivalent Series Resistance (ESR)	30 Ω max.
Nominal Drive Level	200uW typical and 350uW max
Shunt Capacitance (Co)	3.0 pF max
Load Capacitance (CL)	18 pF
Insulation Resistance	500 MΩ min./DC 100V
Aging	+/- 3 ppm / 1st year
Marking	Laser Marking
Unit Weight	0.017+/-0.005 g



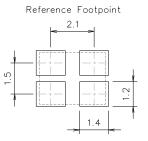
TST DCC Release document

Mechanical Dimensions (mm):

Base



Recommended Land Pattern: (unit: mm)



Marking:

Line 1: Frequency (25.00)

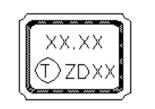
Line 2: TST Logo + Crystal Product Code + Date Code + Traceability code (1 or 2 letters, underline or no underline)

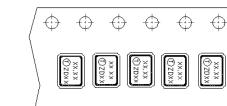
Pin#1

Pin#4

Pin#2

Pin#3





The inner vision of Pin#1, Pin#4 side is XTAL blank mounting pad.

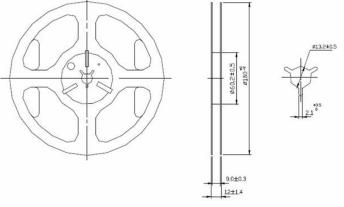
Product Code Table

	2013	2014	2015	2016	
Year	2017	2018	2019	2020	
	2021	2022	2023	2024	
product code	Z	Z	<u>Z</u>	Z	

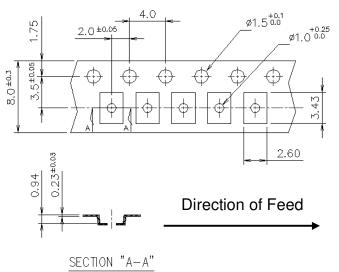
Date Code Table

WK01	WK02	WK03	WK04	WK05	WK06	WK07	WK08	WK09	WK10	WK11	WK12	WK13
Α	В	С	D	E	F	G	Н	I	J	K	L	М
WK14	WK15	WK16	WK17	WK18	WK19	WK20	WK21	WK22	WK23	WK24	WK25	WK26
Ν	0	Р	Q	R	S	Т	U	V	W	Х	Y	Z
WK27	WK28	WK29	WK30	WK31	WK32	WK33	WK34	WK35	WK36	WK37	WK38	WK39
а	b	С	d	е	f	g	h	i	j	k	I	m
WK40	WK41	WK42	WK43	WK44	WK45	WK46	WK47	WK48	WK49	WK50	WK51	WK52
n	0	р	q	r	S	t	u	v	w	х	у	z

Reel Dimensions (mm):



Tape Dimensions (mm):

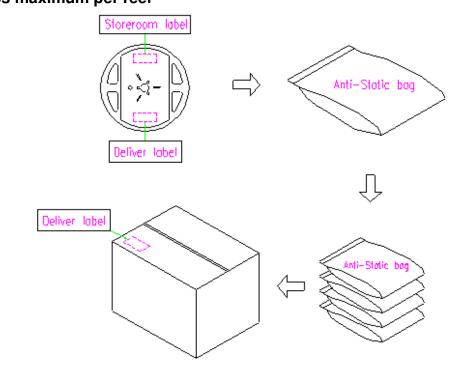


[NOTE]

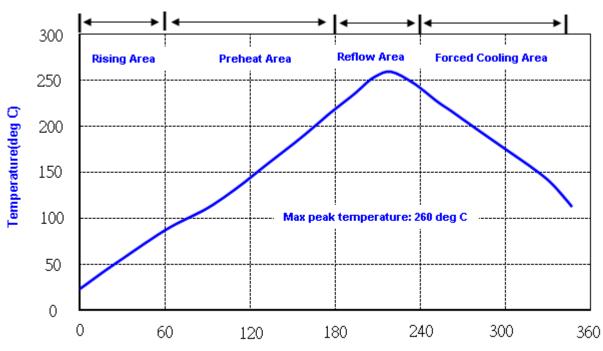
- 1 UNIT : mm.
- 2 UNLESS OTHERWISE SPECIFIED TOLERANCEON DIM. +/-0.1mm.
- 3 MATERIAL : CONDUCTIVE POLYSTYRENE.
- 4 COLOR : BLACK.
- 5 10 PITCHES CUMULATIVETOLERANCE +/-0.2mm.

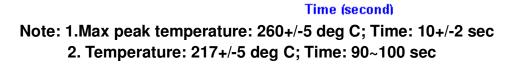
TAI-SAW TECHNOLOGY CO., LTD.

Packing Quantity/Packing: 3K pcs maximum per reel









TST DCC Release document

Reliability Specifications

Test name								
Mechanical characteristics								
resistance to Soldering heat (IR reflow)	Temp./ Duration : 265°C /10sec ×2 times Total time : 4min.(IR-reflow)	EIAJED-4701 -300(301)M(II)						
Vibration	Total peak amplitude : 1.5mmVibration frequency: 10 to 2000 HzSweep period: 20 minuteVibration directions: 3 mutually perpendicularDuration: 2 hr / direc.	MIL-STD 202G method 204						
Mechanical Shock	directions : 3 impacts per axis Acceleration : 3000g's, +20/-0 % Duration : 0.3 ms (total 18 shocks) Waveform : Half-sine	MIL-STD 202G method 213						
Solderability	Solder Temperature:265±5 ℃ Duration time: 5±0.5 seconds.	J-STD-002						
Environmental	characteristics							
Thermal Shock	Heat cycle conditions -40 °C (30min) ←→ 85 °C (30min) * cycle time : 10 times	MIL-STD 883G method 1010.8						
Humidity test	Temperature : 85 ± 2 ℃ Relative humidity : 85% Duration : 96 hours	MIL-STD 202G method 103						
Dry heat	Temperature : $125 \pm 2 ^{\circ}$ C	MIL-STD 202G						
(Aging test)	Duration : 168 hours	method 108A						
Cold resistance (Low Temp Storage)	Temperature :-40 ± 2 ℃ Duration : 96 hours	IEC 60068-2-1						